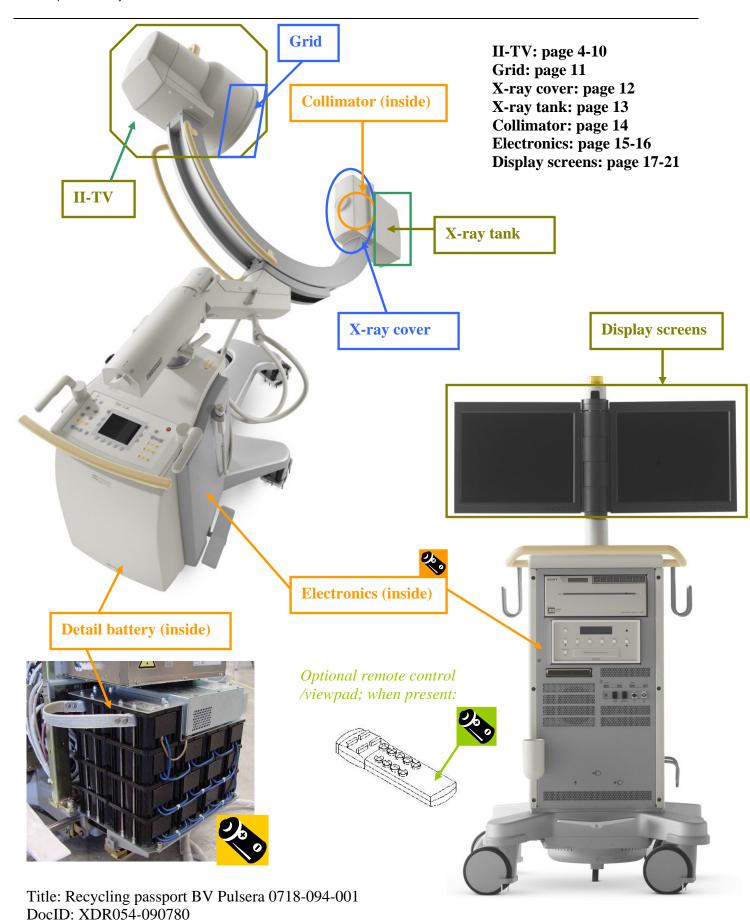
Product name:		BV Pulsera
Identification co	ode	0718-094-001
Total weight (in	Kg)	510 kg (approximately; dependent on specific configuration)
Producer/	Name compan	y: Philips Medical Systems
Manufacturer	Address:	Veenpluis 6
	Zip code:	5684 PC Best
	Country:	Netherlands
	Electronic info	http://www.healthcare.philips.com/us/about/sustainability/recycling/

Recycle Info	Items:	Location
Special attention	 Be aware of possibly contaminated system parts and materials! (biological hazard) For dismantling activities Treatment Facilities must consider the national requirements. For personnel that can come into contact with contaminated material, preventive measures pursuant to national requirements must be taken into account Removal of units / weights can cause the system to tilt! Removal of units / weights can cause unexpected movements of guidances! Release of brakes can cause unexpected movements of 	System parts that were in the patient environment, and that were not disinfected
	guidances! Brakes cannot prevent unexpected movements due to the removal of units /weights! • High-voltage parts (e.g. capacitors) are marked with	
	Before dismantling the vacuum II-Insert, drill a small hole to let air in the insert	II-TV (page 4-10)
	Vacuum glass tube of X-ray tank can implode!	X-ray tank (page 13)
Fluids / Gases	Items:	Location
	• Oil	X-ray tank (page 13)
Batteries	Type:	Location
	Battery, 4x alkaline 1,5V [44 grams] (when option "remote control/viewpad" is present) CR2032 3.0V Lithium coin cell of 3 gram CR2032 3.0V Lithium coin cell of 3.2 gram (when option "Dell	(page 3) Electronics (page 15-16)
To be Removed	PC" is present) Pb - PbO - S.A.E. battery of 34,7 kg; containing lead (Pb), lead dioxide (PbO) and Sulfuric Acid Electrolyte (S.A.E.)	(page 3)

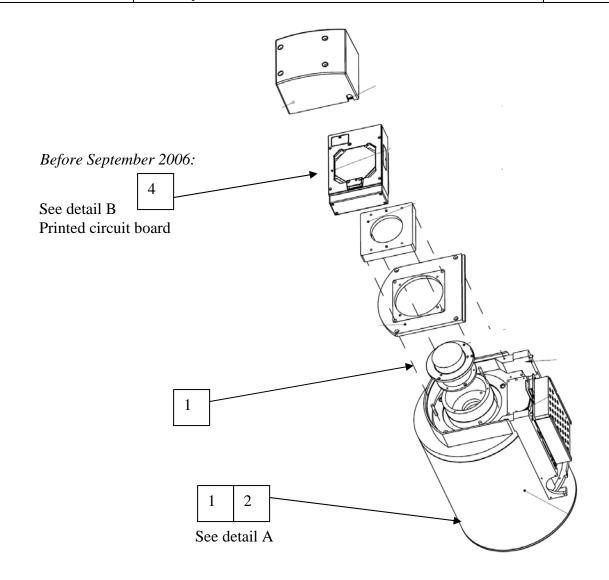
	Substances:	Location
Hazardous	Lead (Pb) for X-ray shielding	II-TV (page 4-10)
A		Grid (page 11)
		X-ray cover (page 12)
		X-ray tank (page 13)
		Collimator (page 14)
Carry .	Lead (Pb) for soldering	Electronics (page 15-
200		16)
		Display screens (page
To be Removed		17-21)
	Cadmium (Cd) + Beryllium Oxide (BeO) inside the II-Insert on the	II-TV (page 4-10)
	glass output window	
	Beryllium Copper (BeCu)	Electronics (page 15-
		16)
	Mercury (Hg) in switch on printed circuit board for systems	II-TV (page 4-10)
	delivered before September 2006	
	Mercury (Hg) in LCD screens	LCD screens (page
		17-21)

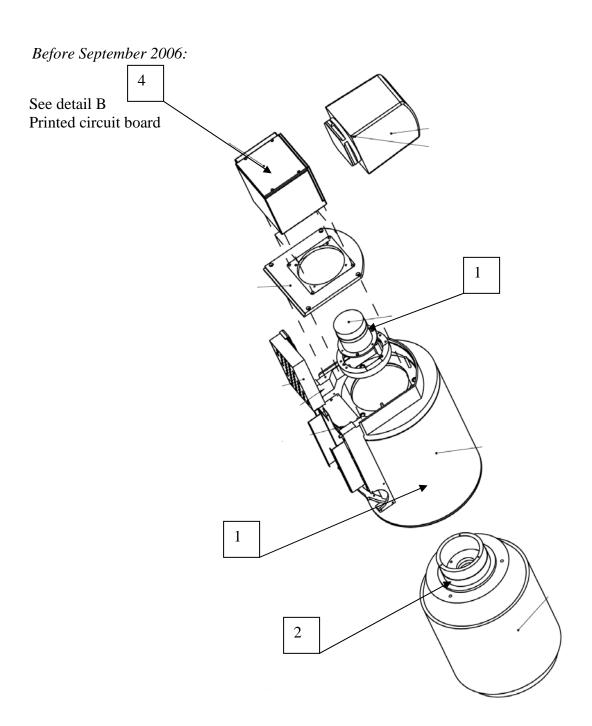
Note: to facilitate recycling, all plastic parts weighing > 50 grams are marked according to ISO11469 & ISO1043.

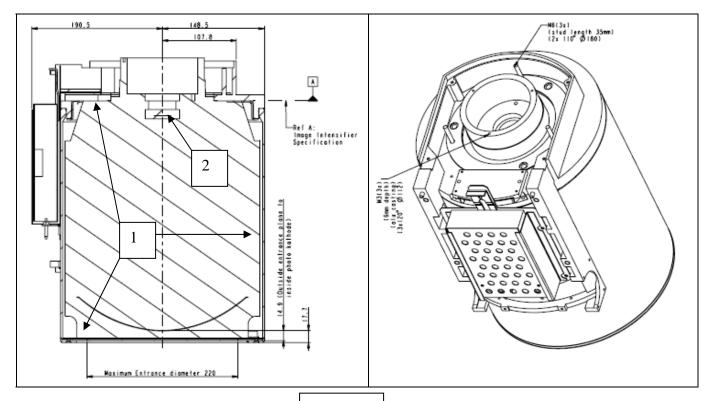


9" II-TV:

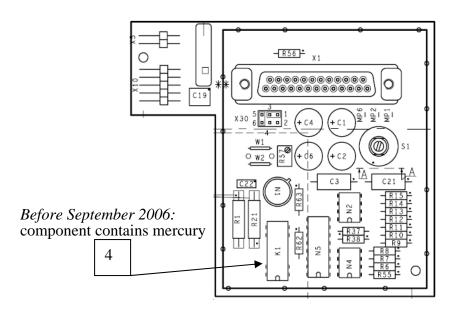
Recycle Info	Items:	Location
Special attention	Before dismantling the vacuum II-Insert, drill a small hole to let air in the insert	
Hazardous	Substances:	Location
\wedge	Lead (Pb)	1, page 4-5
	Cadmium (Cd) + Beryllium Oxide (BeO) inside the II-Insert on the glass output window	2, page 4-5
	Mercury (Hg) in switch on printed circuit board for systems delivered	4, page 4-5 + 7
To be Removed	before September 2006	



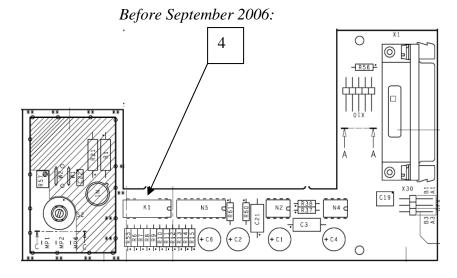




Detail A



Detail B printed circuit board 4522 167 02681 up and including 4522 167 02687

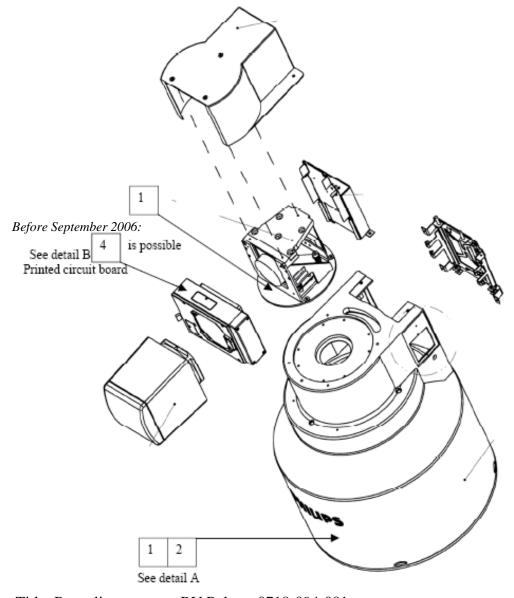


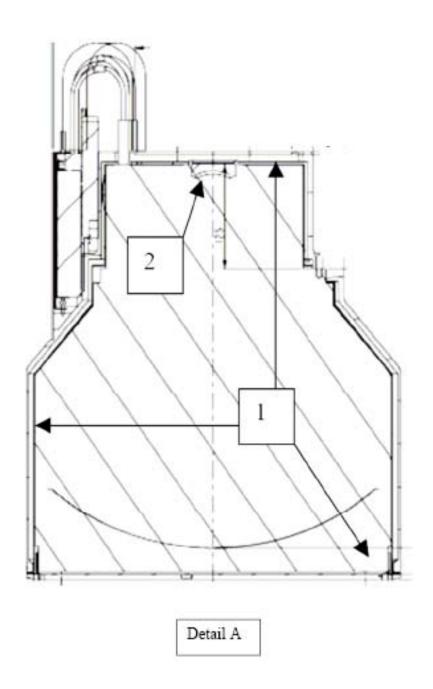
Detail B printed circuit board 4522 167 02431 up and including 4522 167 02439

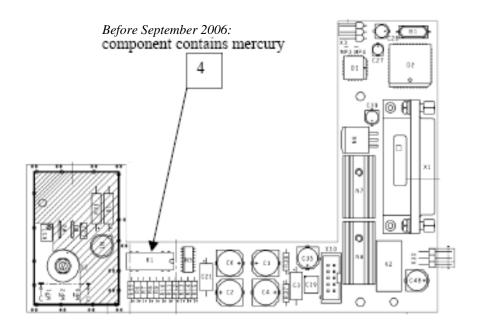
Title: Recycling passport BV Pulsera 0718-094-001

12" II-TV:

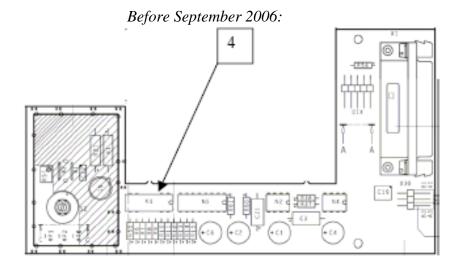
Recycle Info	Items:	Location
Special attention	Before dismantling the vacuum II-Insert, drill a small hole to let air	
\wedge	in the insert	
Hazardous	Substances:	Location
^	Lead (Pb)	1, page 8-9
	Cadmium (Cd) + Beryllium Oxide (BeO) inside the II-Insert on the glass	2, page 8-9
	output window	
	Mercury (Hg) in switch on printed circuit board for systems delivered	4, page 8 + 10
To be Removed	before September 2006	







Detail B printed circuit board 4522 167 03471 up and including 4522 167 03475



Detail B printed circuit board 4522 167 02431 up and including 4522 167 02439

Title: Recycling passport BV Pulsera 0718-094-001

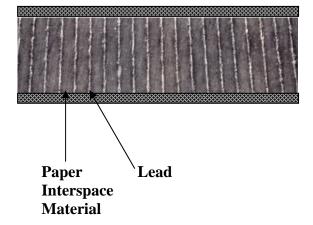


Hazardous	Substances:	Location
	Lead (Pb 99,5%)	Enclosed between cover plates
To be Removed		



Example larger and smaller grid (only 1 present in system)

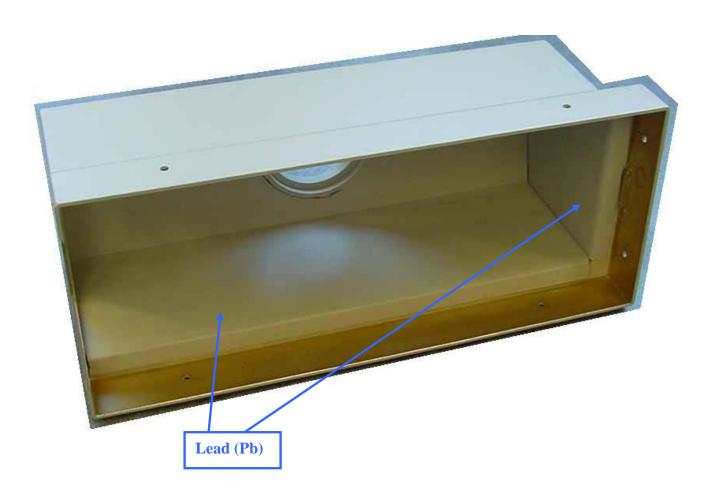
Cross-section of grid:

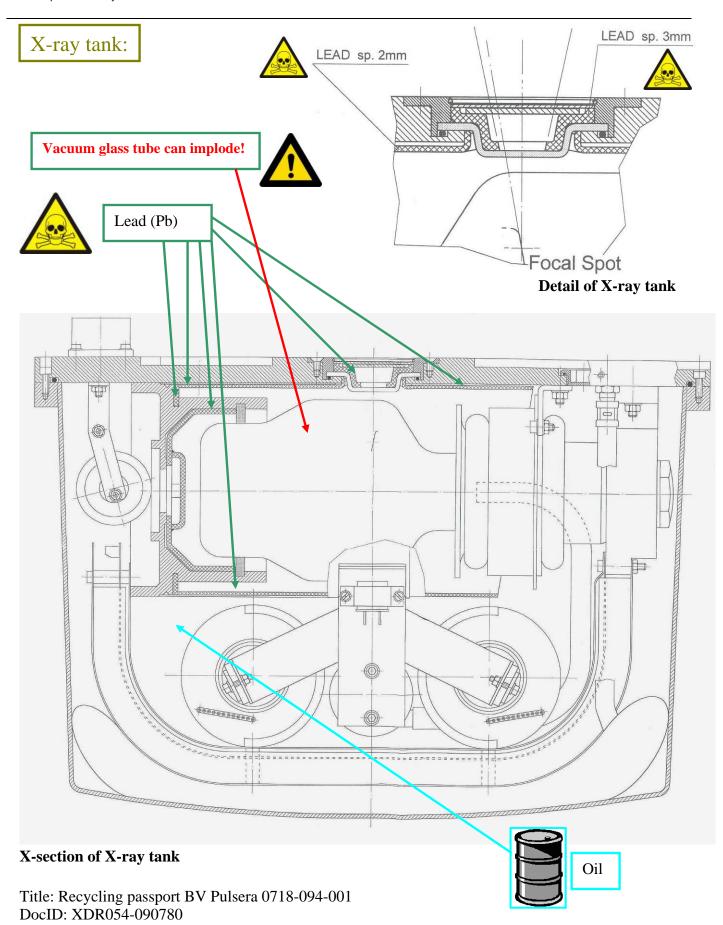


Title: Recycling passport BV Pulsera 0718-094-001

X-ray cover:

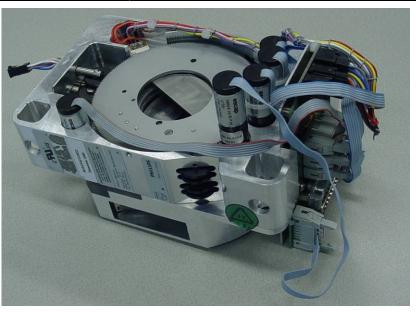
Hazardous	Substances:	Location
To be Removed	Lead (Pb 99,5%)	Glued at inside; see photo below

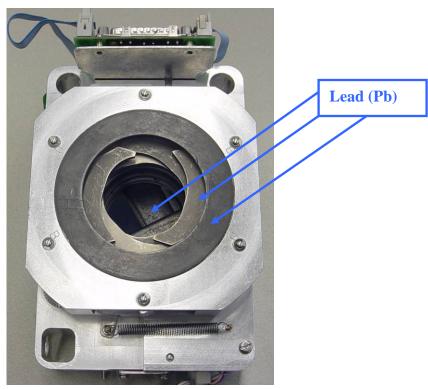




Collimator:

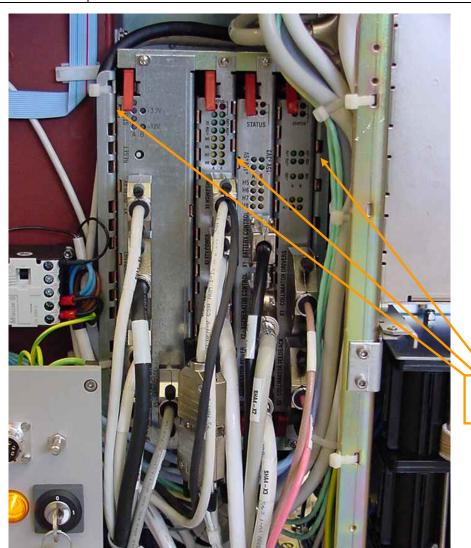
Hazardous	Substances:	Location
To be Removed	Lead (Pb 99,5%); 0,42 kg	Ring of lead, lead on shutters and wedges; See photo below.





Electronics:

	T	
Batteries	Type:	Location
	1x CR2032, 3.0 Volt, 3.0 gram LiMnO2	See picture on page 16
To be Removed	CR2032 3.0V Lithium coin cell of 3.2 gram (when option "Dell PersonalComputer" [Philips-indication: Viewforum hardware] is present)	In Dell PC when present
Hazardous	Substances:	Location
^	BerylliumCopper (BeCu)	Contact springs
	Dolymanic oppor (Docu)	between hardware-
		racks; see photo
205		below.
To be Removed	Lead (Pb) is present in the soldering of some PCBs	PCBs
	(), p	(PrintedCircuitBoards)



BerylliumCopper (BeCu) contact springs









Display screens:

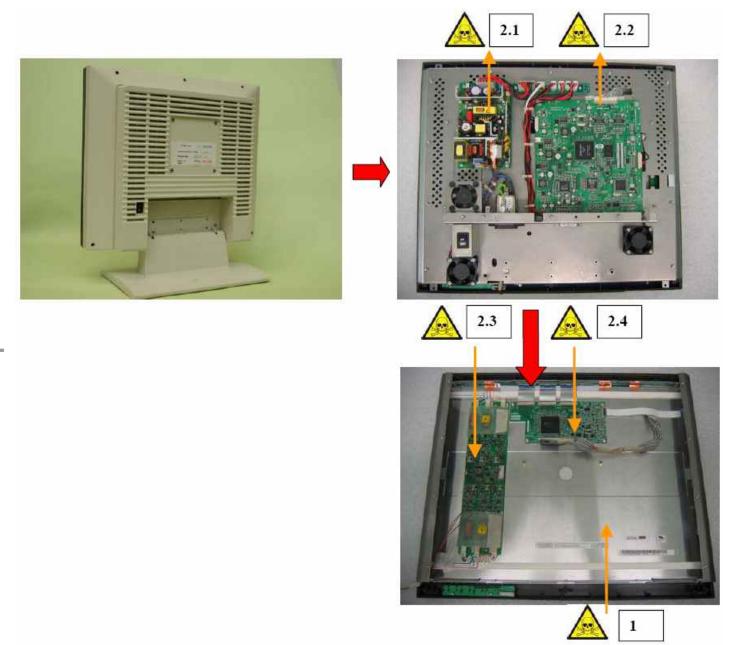
FOLLOWING PAGES PROVIDE INFORMATION ON VARIOUS SCREENS POSSIBLY PRESENT IN THE SYSTEM.

LCD screen FIMI MCL180-L / 9919-320-5089x | PAGE 1 of 2

Hazardous	Substa	nces:	Location
\wedge	Type	Quantity	
	Cd	0	
	Hg	21 mg max. (*)	Next figure (1)
To be Removed	Pb	Lead is present in the	Next figure (2.x)
10 be Removed		soldering process of	
		PCBs	
	Cr ⁶⁺	0	
	PBB	0	
	PBDE	0	
	(*) Mercury is present in Backlight	t lamps: 3.5mg x 6 lamps	

Title: Recycling passport BV Pulsera 0718-094-001

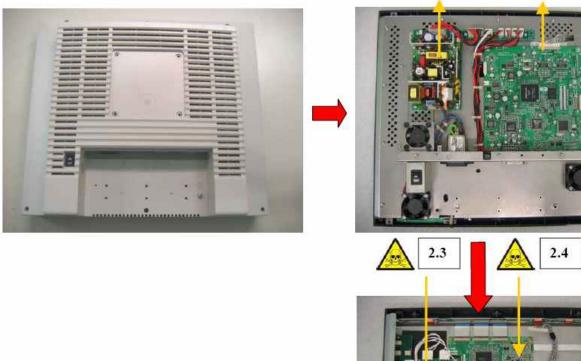
LCD screen FIMI MCL180-L / 9919-320-5089x | PAGE 2 of 2 $\,$



		Material
Fe	6.0 kg	(3.4 kg in the pedestal)
Al	0	-
Cu	0.1 kg	Cables
Plastics	1.5 kg	(0.4 kg in the pedestal)
Boards $(S^2 > 10 \text{cm}^2)$	$96 \text{ cm}^2 / 260 \text{ g}$	S.M.P.S. (item 2.1 in the picture)
	$320 \text{ cm}^2 / 230 \text{ g}$	Logic Board (item 2.2 in the picture)
	$144 \text{ cm}^2 / 66 \text{ g}$	Inverter (item 2.3 in the picture)
	$72 \text{ cm}^2 / 54 \text{ g}$	LCD Driver (item 2.4 in the picture)
CD	3 kg	18"

LCD screen FIMI MCL180-HB / 9919-320-5088x

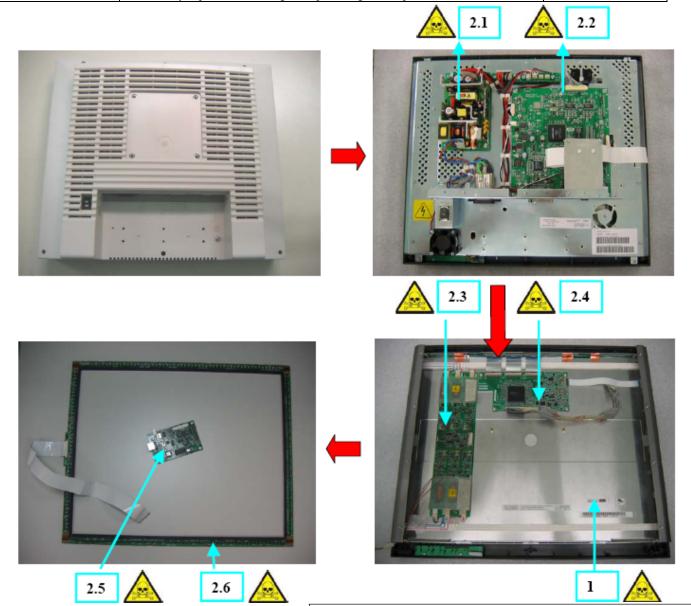
Type Quantity Cd 0 Hg 36 mg max. (*) Figure below (1) Pb Lead is present in the soldering process of PCBs Cr ⁶⁺ 0 PBB 0 PBDE 0 (*) Mercury is present in Backlight lamps: 3mg x 12 lamps	Hazardous	Substances:		Location
Hg 36 mg max. (*) Figure below (1) Pb Lead is present in the soldering process of PCBs Cr ⁶⁺ 0 PBB 0 PBDE 0 (*) Mercury is present in Backlight lamps: 3mg x 12 lamps	\wedge	Type	Quantity	
Pb Lead is present in the soldering process of PCBs Cr ⁶⁺ PBB PBDE (*) Mercury is present in Backlight lamps: 3mg x 12 lamps		Cd	0	
Pb Lead is present in the soldering process of PCBs Cr ⁶⁺ PBB PBDE (*) Mercury is present in Backlight lamps: 3mg x 12 lamps		Hg	36 mg max. (*)	Figure below (1)
soldering process of PCBs Cr ⁶⁺ 0 PBB 0 PBDE 0 (*) Mercury is present in Backlight lamps: 3mg x 12 lamps	o he Removed		Lead is present in the	Figure below (2.x)
Cr ⁶⁺ 0 PBB 0 PBDE 0 (*) Mercury is present in Backlight lamps: 3mg x 12 lamps	o be Removed		soldering process of	
PBB 0 PBDE 0 (*) Mercury is present in Backlight lamps: 3mg x 12 lamps			PCBs	
PBDE 0 (*) Mercury is present in Backlight lamps: 3mg x 12 lamps		Cr ⁶⁺	0	
(*) Mercury is present in Backlight lamps: 3mg x 12 lamps		PBB	0	
		PBDE	0	
2.1 2.2		(*) Mercury is present in Backlight	ht lamps: 3mg x 12 lamps	
			2.1	2.2
	==			C0370



		Material	
Fe	2.3 kg	-	
Al	0		The state of the s
Cu	0.1 kg	Cables	
Plastics	1 kg	-	
Boards $(S^2 > 10 cm^2)$	96 cm ² / 260 g	S.M.P.S. (item 2.1 in the picture)	
	320 cm ² / 230 g	Logic Board (item 2.2 in the picture)	
	80 cm ² / 180 g	Inverter (item 2.3 in the picture)	
	100 cm ² / 50 g	LCD Driver (item 2.4 in the picture)	Marian Property and Personal Property and Pe
	46 cm ² / 40 g	PCB Backlight Stabilization (item 2.5 in the picture)	
LCD	2.7 kg	18"	
			2.5 2.5 1
			3000 John 1990 J

LCD screen FIMI MCL180-LT / 9919-320-5092x

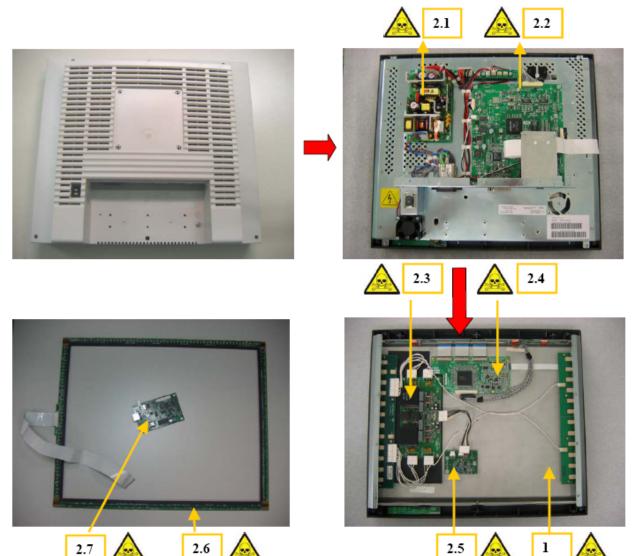
Hazardous	Substances:		Location
\wedge	Type	Quantity	
	Cd	0	
(o. o.	Hg	21mg max. (*)	Next figure (1)
	Pb	Lead is present in the soldering process of PCBs	Next figure (2.x)
To be Removed	Cr ⁶⁺	0	
	PBB	0	
	PBDE	0	
	(*) Mercury is present in Backlight lamps: 3.5mg x 6 lamps		



	Material		
ľ	Fe	2.3 kg	-
	Al	0	-
	Cu	0.2 kg	Cables
	Plastics	1 kg	-
	Boards $(S^2 > 10 \text{cm}^2)$	96 cm ² / 260 g	S.M.P.S. (item 2.1 in the picture)
		320 cm ² / 230 g	Logic Board (item 2.2 in the picture)
4		80 cm ² / 180 g	Inverter (item 2.3 in the picture)
		100 cm ² / 50 g	LCD Driver (item 2.4 in the picture)
		71 cm ² / 80 g	PCB Touch-Screen controller (item 2.5 in the picture)
		40 cm ² / 50 g	PCB Touch-Screen (item 2.6 in the picture)
	LCD	2.7 kg	18"

LCD screen FIMI MCL180-HBT / 9919-320-5091x

Hazardous	azardous Substances:		Location
\wedge	Type	Quantity	
	Cd	0	
	Hg	36 mg max. (*)	Next figure (1)
	Pb	Lead is present in the	Next figure (2.x)
To be Removed		soldering process of PCBs	
	Cr ⁶⁺	0	
	PBB	0	
	PBDE	0	
	(*) Mercury is present in Backlight lamps: 3 mg x 12 lamps		



Material		
Fe	2.3 kg	-
Al	0	-
Cu	0.2 kg	Cables
Plastics	1 kg	-
Boards $(S^2 > 10cm^2)$	96 cm ² / 260 g	S.M.P.S. (item 2.1 in the picture)
	320 cm ² / 230 g	Logic Board (item 2.2 in the picture)
	80 cm ² / 180 g	Inverter (item 2.3 in the picture)
	100 cm ² / 50 g	LCD Driver (item 2.4 in the picture)
	46 cm ² / 40 g	PCB Backlight Stabilization (item 2.5 in the picture)
	71 cm ² / 80 g	PCB Touch-Screen controller (item 2.6 in the picture)
	40 cm ² / 50 g	PCB Touch-Screen (item 2.7 in the picture)
LCD	2.7 kg	18"